

High Performance Schottky Rectifier, 2 A



SMA (DO-214AC)



FEATURES

- Low forward voltage drop
- Guard ring for enhanced ruggedness and long term reliability
- Small foot print, surface mountable
- High frequency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

PRODUCT SUMMARY	
Package	SMA (DO-214AC)
$I_{F(AV)}$	2 A
V_R	60 V
V_F at I_F	See Electrical table
I_{RM}	7.5 mA at 125 °C
T_J max.	150 °C
Diode variation	Single
E_{AS}	2.0 mJ

DESCRIPTION

The VS-20MQ060TRNPbF surface mount Schottky rectifier has been designed for applications requiring low forward drop and very small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS			
SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Rectangular waveform	2	A
V_{RRM}		60	V
I_{FSM}	$t_p = 5 \mu s$ sine	40	A
V_F	2 A _{pk} , $T_J = 125$ °C	0.68	V
T_J	Range	-55 to +150	°C

VOLTAGE RATINGS			
PARAMETER	SYMBOL	VS-20MQ060NTRPbF	UNITS
Maximum DC reverse voltage	V_R	60	V
Maximum working peak reverse voltage	V_{RWM}		

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current See fig. 4	I _{F(AV)}	50 % duty cycle at T _C = 110 °C, rectangular waveform On PC board 9 mm ² island (0.013 mm thick copper pad area)		2	A
		50 % duty cycle at T _C = 120 °C, rectangular waveform On PC board 9 mm ² island (0.013 mm thick copper pad area)		1.5	
Maximum peak one cycle non-repetitive surge current See fig. 6	I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated V _{RRM} applied	40	A
		10 ms sine or 6 ms rect. pulse		10	
Non-repetitive avalanche energy	E _{AS}	T _J = 25 °C, I _{AS} = 1 A, L = 4 mH		2.0	mJ
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μs Frequency limited by T _J maximum V _A = 1.5 x V _R typical		1.0	A

**ELECTRICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum forward voltage drop See fig. 1	$V_{FM}^{(1)}$	2 A	0.78	V
		1.5 A	0.71	
		1 A	0.63	
		2 A	0.68	
		1.5 A	0.63	
		1 A	0.57	
Maximum reverse leakage current See fig. 2	$I_{RM}^{(1)}$	$T_J = 25\text{ }^{\circ}\text{C}$	0.5	mA
		$T_J = 125\text{ }^{\circ}\text{C}$	7.5	
Threshold voltage	$V_{F(TO)}$	$T_J = T_J \text{ maximum}$	0.45	V
Forward slope resistance	r_t		86.8	m Ω
Typical junction capacitance	C_T	$V_R = 10\text{ V}_{DC}$, $T_J = 25\text{ }^{\circ}\text{C}$, test signal = 1 MHz	31	pF
Typical series inductance	L_S	Measured lead to lead 5 mm from package body	2.0	nH
Maximum voltage rate of change	dV/dt	Rated V_R	10 000	V/ μ s

Note

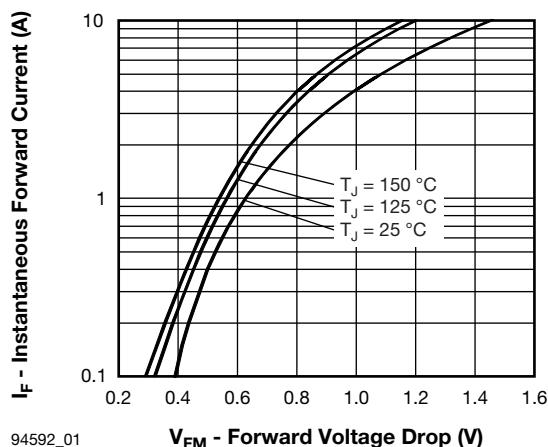
(1) Pulse width < 300 μ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	$T_J^{(1)}, T_{Stg}$		-55 to +150	$^{\circ}\text{C}$
Maximum thermal resistance, junction to ambient	R_{thJA}	DC operation	80	$^{\circ}\text{C/W}$
Approximate weight			0.07	g
			0.002	oz.
Marking device		Case style SMA (DO-214AC) (similar D-64)	2H	

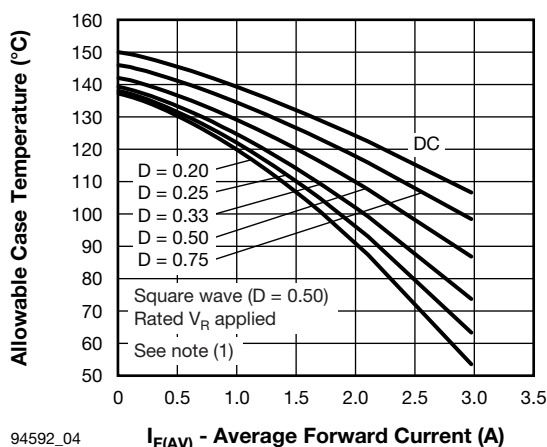
Note

(1) $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$ thermal runaway condition for a diode on its own heatsink



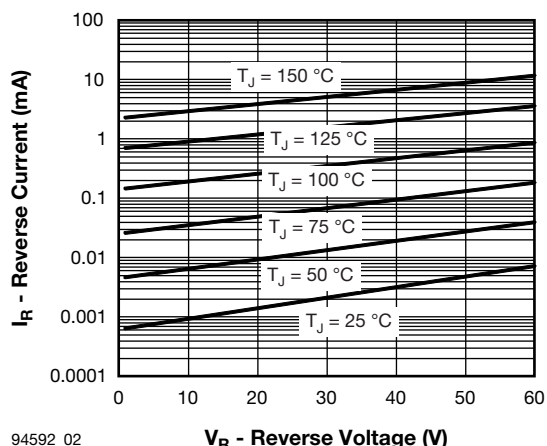
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Fig. 1 - Maximum Forward Voltage Drop Characteristics



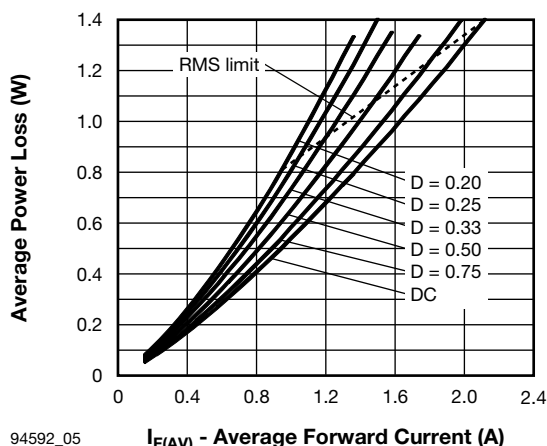
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Fig. 4 - Maximum Average Forward Current vs. Allowable Lead Temperature



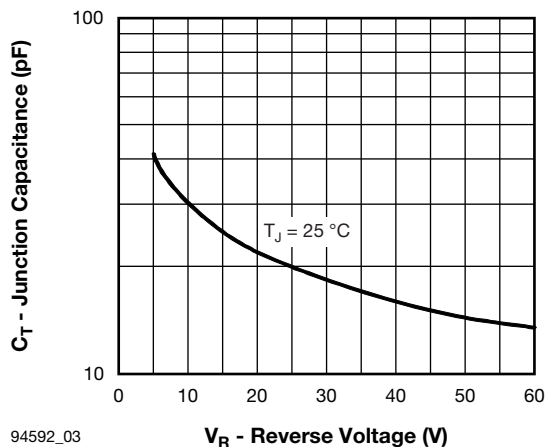
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Fig. 2 - Typical Peak Reverse Current vs. Reverse Voltage



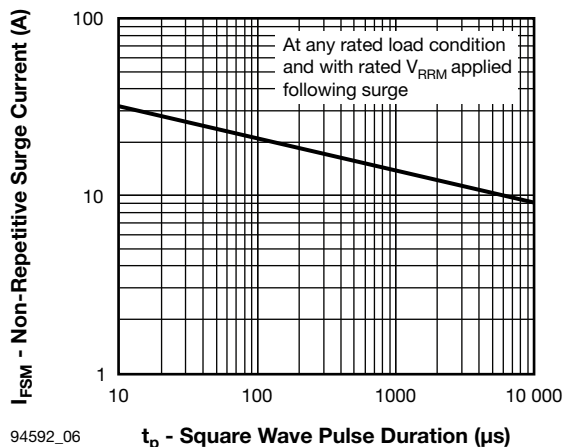
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Fig. 5 - Maximum Average Forward Dissipation vs. Average Forward Current



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Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage



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Fig. 6 - Maximum Peak Surge Forward Current vs. Pulse Duration

Note

- (1) Formula used: $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$;
 P_d = forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
 P_{dREV} = inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at $V_{R1} = 80\%$ rated V_R



ORDERING INFORMATION TABLE

Device code	VS-	20	M	Q	060	N	TR	PbF
	1	2	3	4	5	6	7	8
1	- Vishay Semiconductors product							
2	- Current rating (20 = 2 A)							
3	- M = SMA							
4	- Q = Schottky "Q" series							
5	- Voltage rating (060 = 60 V)							
6	- N = new SMA							
7	- TR = tape and reel							
8	- PbF = lead (Pb)-free							

ORDERING INFORMATION (Example)			
PREFERRED P/N	PREFERRED PACKAGE CODE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-20MQ060NTRPbF	5AT	7500	13" diameter plastic tape and reel

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95400
Part marking information	www.vishay.com/doc?95403
Packaging information	www.vishay.com/doc?95404
SPIICE model	www.vishay.com/doc?95396

SMA

DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout





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